

NCEP40T17G

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP40T17G uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

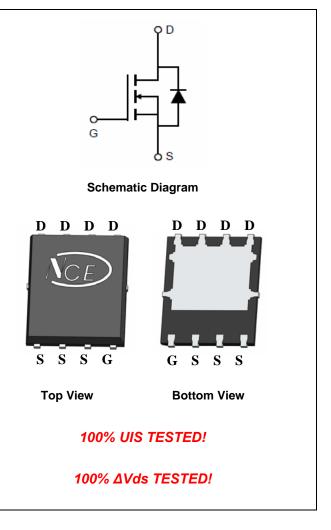
General Features

V_{DS} =40V,I_D =170A
R_{DS(ON)}=1.25mΩ (typical) @ V_{GS}=10V
R_{DS(ON)}=1.55mΩ (typical) @ V_{GS}=4.5V

- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP40T17G	NCEP40T17G	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	40	V	
Gate-Source Voltage	V _{GS}	±20	V	
Drain Current-Continuous (Silicon Limited)	Ι _D	170	А	
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	120	А	
Pulsed Drain Current (Package Limited)	I _{DM}	400	А	
Maximum Power Dissipation	PD	95	W	
Derating factor		0.76	W/°C	
Single pulse avalanche energy (Note 5)	E _{AS}	1200	mJ	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C	





NCEP40T17G

Thermal Characteristic

Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Symbol Condition		Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	S V _{GS} =±20V,V _{DS} =0V		-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.5	2.2	V
Drain Course On State Desistance	D	V _{GS} =10V, I _D =85A	-	1.25	1.5	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =85A	-	1.55	1.95	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =85A	-	80	-	S
Dynamic Characteristics (Note4)	····					•
Input Capacitance	C _{lss}	<u>)/ 00)//)/ 0)/</u>	-	7400	8800	PF
Output Capacitance	C _{oss}	V_{DS} =20V, V_{GS} =0V,	-	1930	2300	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	110	130	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	14.1	-	nS
Turn-on Rise Time	tr	V _{DD} =20V,I _D =85A	-	7.9	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =1.6 Ω	-	56.5	-	nS
Turn-Off Fall Time	t _f		-	9.6	-	nS
Total Gate Charge	Qg		-	125	140	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=20V, I_{D}=85A,$	-	18		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	13		nC
Drain-Source Diode Characteristics	· ·			. <u> </u>		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =85A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	170	А
Reverse Recovery Time	t _{rr}	T_J = 25°C, I_F = I_S	-		35	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	_		124	nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300 μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^\circ \! \mathrm{C}$,V_DD=20V,V_G=10V,L=0.5mH,Rg=25 Ω



V_{GS}=4.5V

150 175

200

I_D=85A

125

100

25° C

0.8

1.0

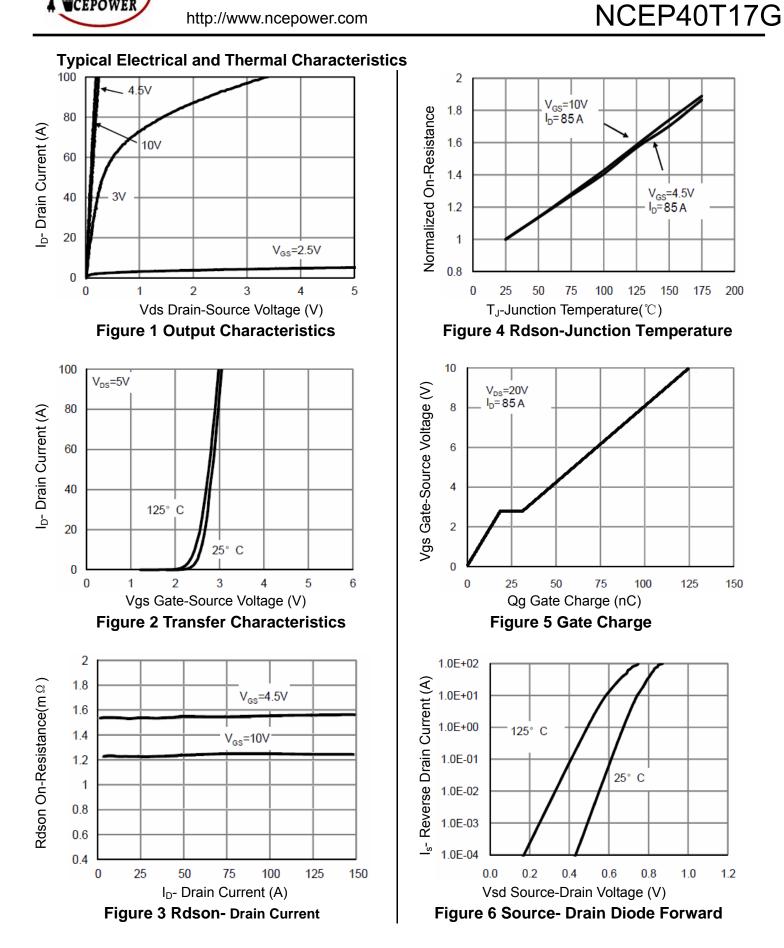
1.2

125

150



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Pb Free Product

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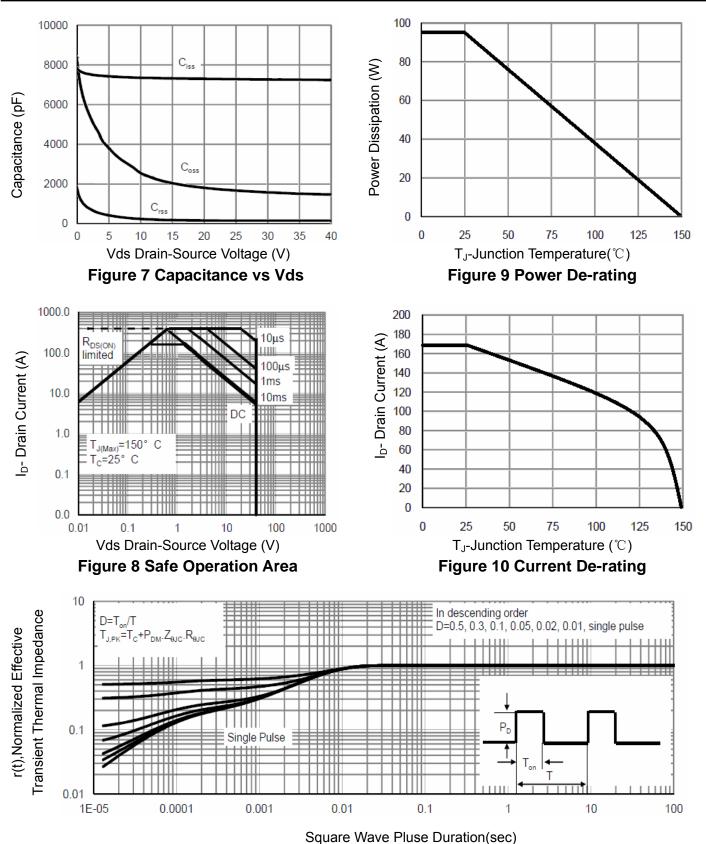


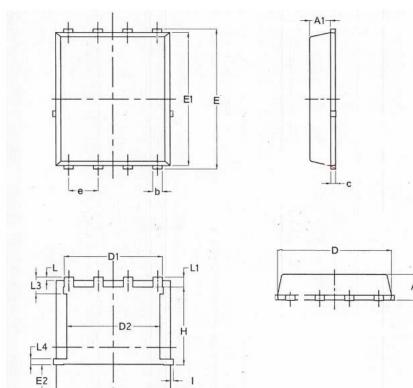
Figure 11 Normalized Maximum Transient Thermal Impedance





NCEP40T17G

DFN5X6-8L Package Information



L2

Symbol	Dimensions In Millimeters			Dimensions In Inches				
	Min.	Nom.	Max.	Min.	Nom.	Max.		
А	0.90	1.10	1.17	0.0354	0.0433	0.0461		
A1	0.824	0.897	0.97	0.0324	0.0353	0.0382		
b	0.33	0.41	0.50	0.0130	0.0161	0.0197		
С	0.150	0.20	0.250	0.0059	0.0079	0.0098		
D	4.80	4.90	5.00	0.1890	0.1929	0.1969		
D1	3.91	4.22	4.36	0.1539	0.1661	0.1717		
D2	3.85	4.00	4.15	0.1516	0.1575	0.1634		
E	5.90	60.5	6.15	0.2323	0.2382	0.2421		
E1	5.65	5.76	5.85	0.2224	0.2268	0.2303		
E2	1.10	/	1	0.0433	1	1		
е		1.27 BSC			0.050 BSC			
L	0.05	0.15	0.25	0.0020	0.0059	0.0098		
L1	0.38	0.425	0.50	0.0150	0.0167	0.0197		
L2	0.51	0.785	0.86	0.0201	0.0309	0.0339		
L3	0.55	0.70	0.85	0.0217	0.0276	0.0335		
L4	0.10	0.25	0.40	0.0039	0.0098	0.0157		
Н	3.25	3.35	3.58	0.1280	0.1319	0.1409		
I	0	1	0.18	0	1	0.0071		







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